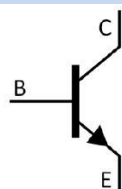


/ Descriptions

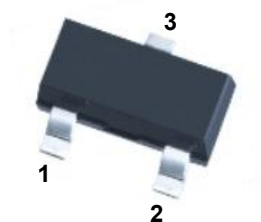
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning

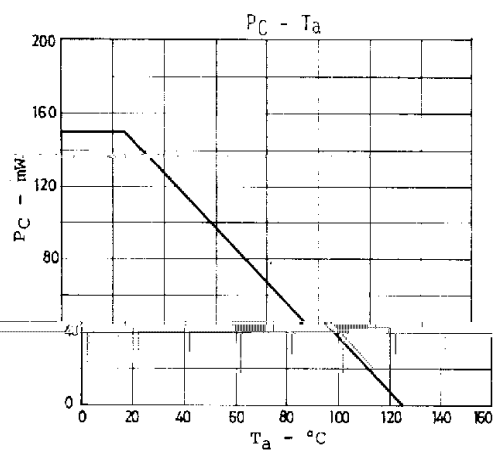
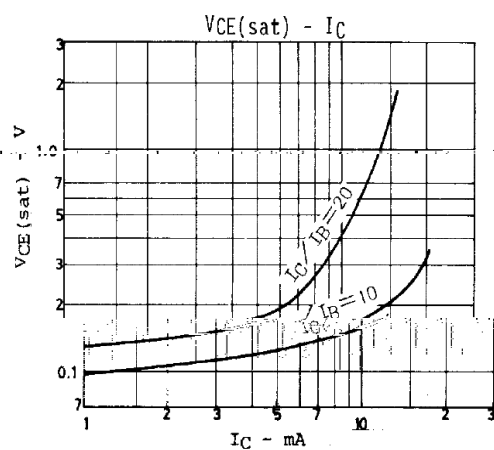
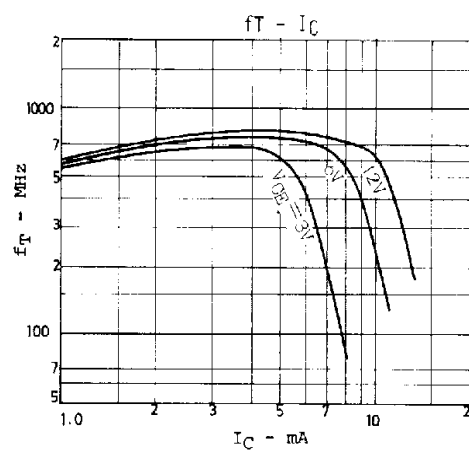
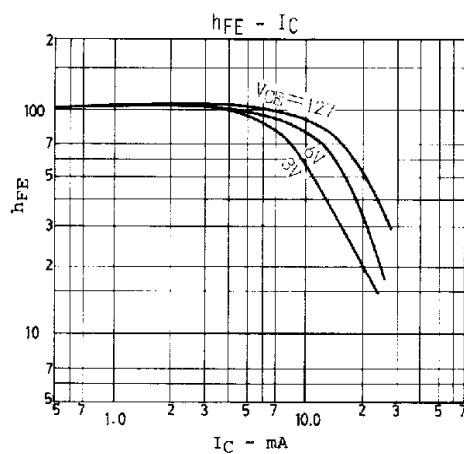
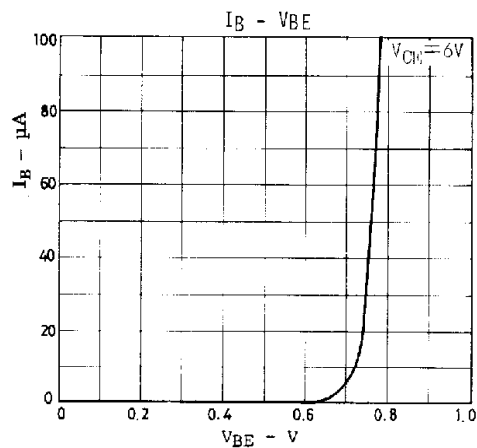
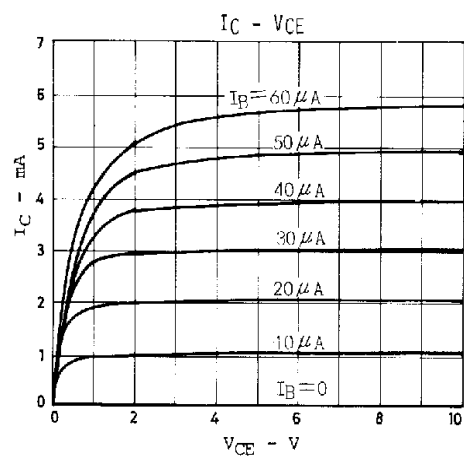


/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

/ Electrical Characteristics(Ta=25)

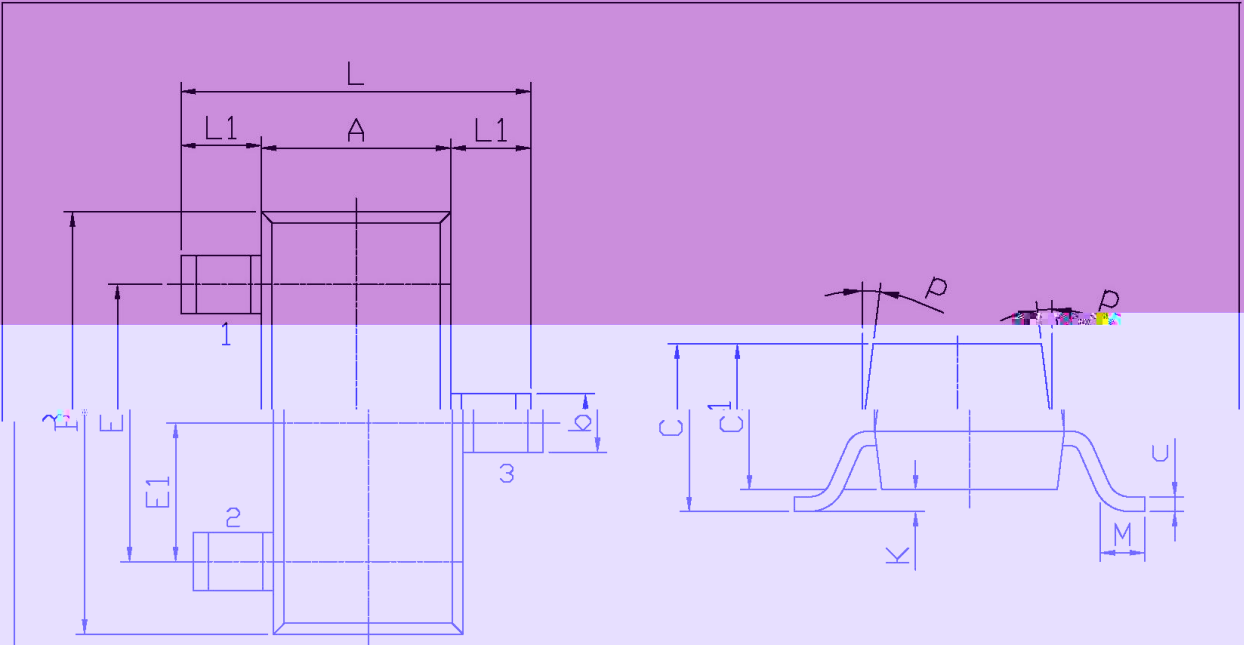
/ Electrical Characteristic Curve



/ Package Dimensions

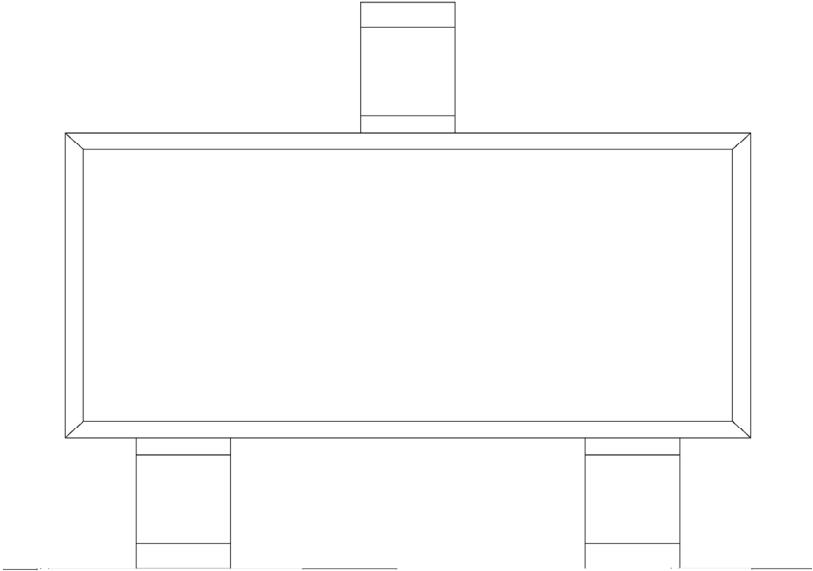
SOT-23

单位: mm

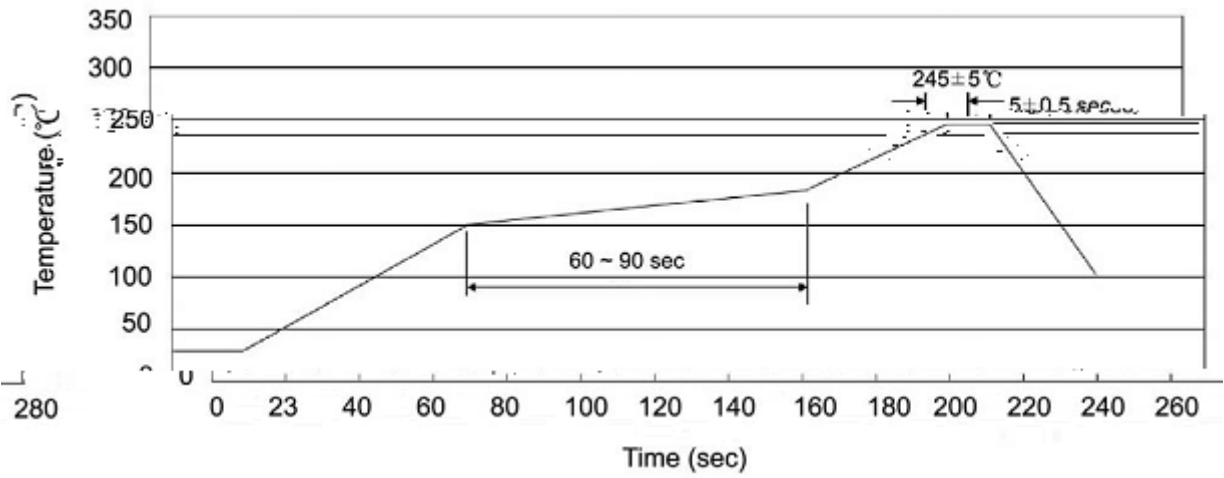


Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.5	0.7

/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices